



Molded Inductor 1.0µH



APPLICATIONS

- Battery-powered devices
- Portable devices
- Embedded computing
- High-current SMPS
- High-frequency SMPS
- POL converters
- FPGA

FEATURES

- Size 13.5mmx12.6mmx6.2mm
- Molded Construction
- Low Audible Noise
- Soft Saturation
- Stable Over High Temperatures
- Max Operating Temp +155°C
- RoHS/REACH-Compliant, Halogen-Free

ELECTRICAL CHARACTERISTICS				
Parameter			Value	Unit
Inductance (1)	L	±20%	1.0	μΗ
Resistance	RDC	typ	1.5	mΩ
Resistance MAX	RDC MAX	max	1.8	$\boldsymbol{m}\boldsymbol{\Omega}$
Rated Current (2)	I _R	typ	25.5	Α
Saturation Current 25°C (3)	SAT 25°C	typ	43	Α
Saturation Current 100°C (4)	SAT 100°C	typ	43	Α
Resonance Frequency	fr	typ	41	MHz

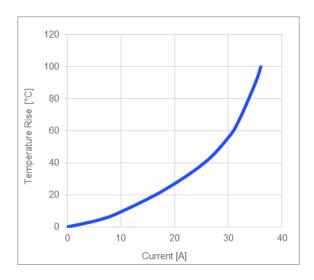
GENERAL SPECIFICATIONS		
Measured at 100kHz, 100mA		
Rated current will cause the coil temperature rise ΔT of 40K I_R measured with the inductor soldered in a single-layer PCB. Copper layer thickness 35 μ m Cu / PCB size 30x50mm. Temperature behavior dependent on circuit design, PCB layout, proximity to other components, and trace dimensions and thickness.		
Saturation current will cause L to drop from 30% at 25°C ambient temperature		
Saturation current will cause L to drop from 30% at 100°C ambient temperature		
Electrical specifications measured at 25°C, 35% RH if not given differently		
Operating temperature: -40°C to +155°C (including temp rise)		
Should not exceed +155°C under worst-case operation conditions		
Tape and Reel packaging: -10°C to +40°C Humidity: <50% RH		

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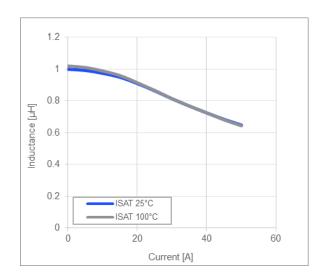


TYPICAL PERFORMANCE CURVES

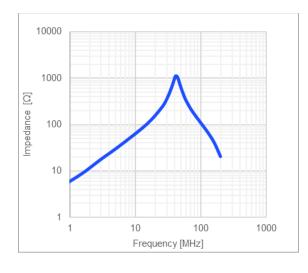
Temperature Rise vs. Current



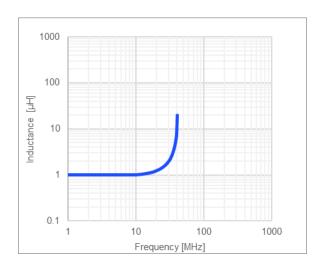
Inductance vs. Current



Impedance vs. Frequency



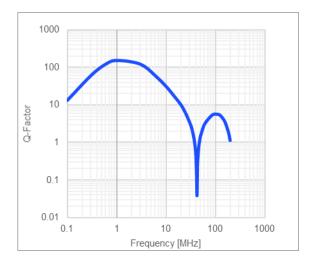
Inductance vs. Frequency



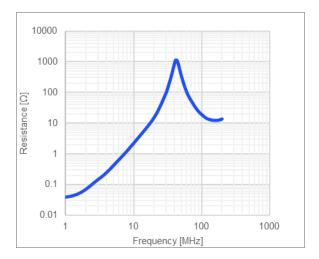
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Quality Factor vs. Frequency

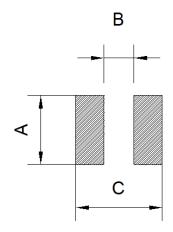


AC Resistance vs. Frequency





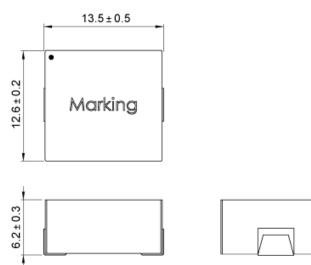
LAND PATTERN		
Dimensions		
A	5.0 ref.	
В	8.0 ref.	
С	14.50 ref.	
	(unit in mm)	



PRODUCT PACKAGE AND DIMENSIONS

Dimensions

(unit in mm)



	TOP MARKING		
	М	arking	
	Start of Winding		· (dot)
	Inductance Code		1R0
1	MPS Code		MPS
	Date Code		YYWW
1			

 2.3 ± 0.3

4.0±0.3



ORDERING INFORMATION					
Part Number	L (1)	RDC	I _R ⁽²⁾	I _{SAT 25°C} (3)	I _{SAT 100°C} (4)
	typ (µH)	typ (mΩ)	typ (A)	typ (A)	typ (A)
MPL-AY1265-R47	0.47	0.89	33	64	64
MPL-AY1265-R56	0.56	1.1	31	58	58
MPL-AY1265-R68	0.68	1.25	29	51	51
MPL-AY1265-R82	0.82	1.3	27	46	46
MPL-AY1265-1R0	1.0	1.5	25.5	43	43
MPL-AY1265-1R2	1.2	1.8	24	37	37
MPL-AY1265-1R5	1.5	2.3	22	34	34
MPL-AY1265-1R8	1.8	3.3	20	29	29
MPL-AY1265-2R2	2.2	3.7	17	26.5	26.5
MPL-AY1265-3R3	3.3	5.5	16	25	25
MPL-AY1265-4R7	4.7	7.0	14	23	23
MPL-AY1265-5R6	5.6	8.6	13	20	20
MPL-AY1265-6R8	6.8	9.9	12	19.5	19.5
MPL-AY1265-8R2	8.2	12.5	11.5	18	18
MPL-AY1265-100	10	13.3	10.7	16	16
MPL-AY1265-150	15	21.8	8.5	12	12
MPL-AY1265-220	22	31.4	7	9	9

GENERAL SPECIFICATIONS		
(1) Inductance	Measured at 100kHz, 100mA	
(2) Rated Current	Rated current will cause the coil temperature rise ΔT of 40K I _R measured with the inductor soldered in a single-layer PCB. Copper layer thickness 35μm Cu / PCB size 30x50mm. Temperature behavior dependent on circuit design, PCB layout, proximity to other components, and trace dimensions and thickness.	
(3) Saturation Current 25°C	Saturation current will cause L to drop from 30% at 25°C ambient temperature	
(4) Saturation Current 100°C	Saturation current will cause L to drop from 30% at 100°C ambient temperature	
Temperature Test Condition	Electrical specifications measured at 25°C, 35% RH if not given differently	
Operating Condition	Operating temperature: -40°C to +155°C (including temp rise)	
	Should not exceed +155°C under worst-case operation conditions	
Storage Condition	Tape and Reel packaging: -10°C to +40°C	
	Humidity: <50% RH	

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